STB14N80K5



N-channel 800 V, 0.400 Ω typ., 12 A MDmesh[™] K5 Power MOSFET in a D²PAK package

Datasheet - production data

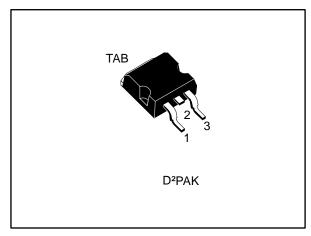
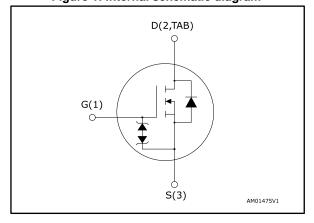


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	
STB14N80K5	800 V	0.445 Ω	12 A	

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Marking Package	
STB14N80K5	14N80K5	D²PAK	Tape and reel

Contents STB14N80K5

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STB14N80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 30	V
I_D	Drain current (continuous) at T _C = 25 °C	12	Α
I _D	I _D Drain current (continuous) at T _C = 100 °C		Α
$I_D^{(1)}$	Drain current (pulsed)	48	Α
P _{TOT}	Total dissipation at T _C = 25 °C	130	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	\//n =
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	FF to 150	°C
T _J	Operating junction temperature range	- 55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.96	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	30	°C/W

Notes

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	4	А
E _{AS}	Single pulse avalanche energy (starting T_j = 25 °C, I_D = I_{AR} , V_{DD} = 50 V)	270	mJ

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}}$ I_{SD} \leq 12 A, di/dt \leq 100 A/ μ s; V_{DS(peak)} < V(BR)DSS,V_{DD}= 640 V

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2 oz Cu

Electrical characteristics STB14N80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 6 A		0.400	0.445	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		ı	620	•	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	1	60	ı	pF
C_{rss}	Reverse transfer capacitance	· 63 – • ·	ı	8.0	ı	pF
$C_{o(tr)}^{(1)}$	Equivalent capacitance time related	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$	ı	107	ı	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V	ı	39	ı	pF
R_g	Intrinsic gate resistance	$f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$	-	6.5	•	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 12 \text{ A}$	-	22	-	nC
Q_gs	Gate-source charge	V _{GS} = 10 V (see Figure 16: "Test circuit for gate charge behavior"	ı	4.3	•	nC
Q_{gd}	Gate-drain charge		-	16.5	-	nC

Notes:

⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_{DS} increases from 0 to 80% V_{DSS}

Table 7: Switching times

Table 11 ownering times						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 400 V, I _D =6 A,	-	12.5	-	ns
t _r	Rise time	$R_G = 4.7 \Omega$	ı	8	-	ns
$t_{d(off)}$	Turn-off delay time	V _{GS} = 10 V see (Figure 15: "Test circuit for	-	33	-	ns
t _f	Fall time	resistive load switching times" and Figure 20: "Switching time waveform")	-	10	-	ns

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		12	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		48	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 12 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 12 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, V_{DD}$	-	365		ns
Q_{rr}	Reverse recovery charge	= 60 V (see Figure 17: "Test circuit for	-	4.77		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	ı	26		А
t _{rr}	Reverse recovery time	$I_{SD} = 12 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s V}_{DD}$	-	485		ns
Qrr	Reverse recovery charge	= 60 V, T _j = 150 °C (see Figure 17: "Test circuit for inductive load switching and diode recovery times")	-	5.85		μC
I _{RRM}	Reverse recovery current		-	24		А

Notes:

Table 9: Gate-source Zener diode

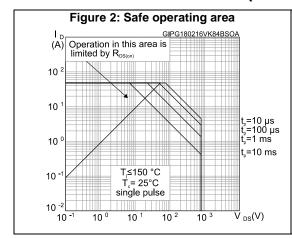
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	I_{GS} = ± 1mA, I_{D} = 0 A	30	-	-	V

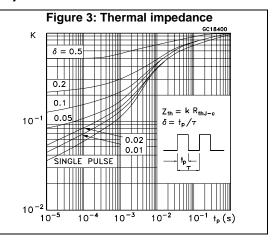
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

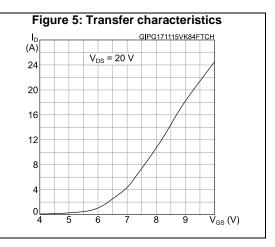
⁽¹⁾Pulse width limited by safe operating area

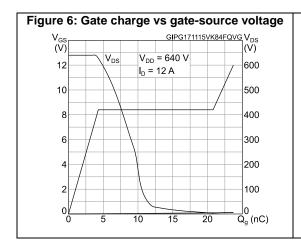
⁽²⁾Pulsed: pulse duration = 300 µs, duty cycle 1.5%

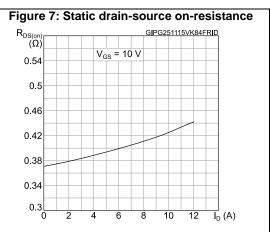
2.2 Electrical characteristics (curves)











STB14N80K5 Electrical characteristics

Figure 8: Capacitance variations

C
(pF)

103

102

101

f = 1 MHz

C
(RSS)

C
(RSS)

C
(DSS)

Figure 9: Normalized gate threshold voltage vs temperature

V GS(th) GIPG171115VK84FVTH
(norm.)

1.2

1.0

0.8

0.6

0.4

-75

-25

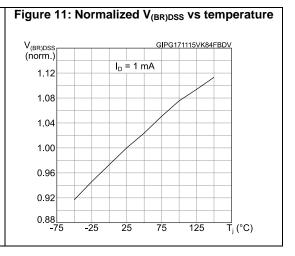
25

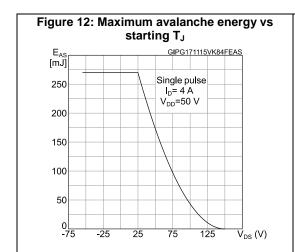
75

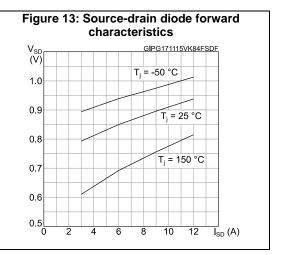
125

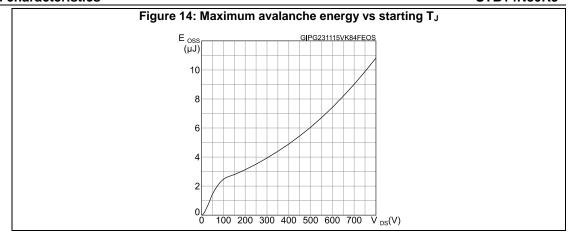
T j(°C)

Figure 10: Normalized on-resistance vs temperature R_{DS(on)} (norm.) GIPG171115VK84FRON V_{GS} = 10 V 2.6 2.2 1.8 1.4 1.0 0.6 0.2L -75 T_j (°C) 25 75 125 -25









STB14N80K5 Test circuits

3 Test circuits

Figure 15: Test circuit for resistive load switching times

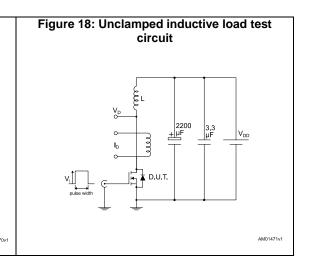
Figure 16: Test circuit for gate charge behavior

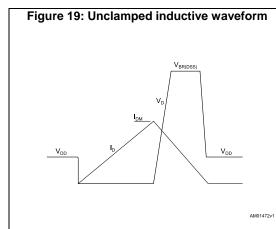
12 V 47 kΩ 100 nF D.U.T.

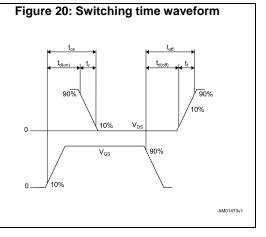
VGS 1 kΩ 1 kΩ 1 kΩ

AM01469v1

Figure 17: Test circuit for inductive load switching and diode recovery times







Package information 4

In order to meet environmental requirements, ST offers these devices in different grades of $\mathsf{ECOPACK}^{\$}$ packages, depending on their level of environmental compliance. $\mathsf{ECOPACK}^{\$}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

D²PAK (TO-263) type A package information 4.1

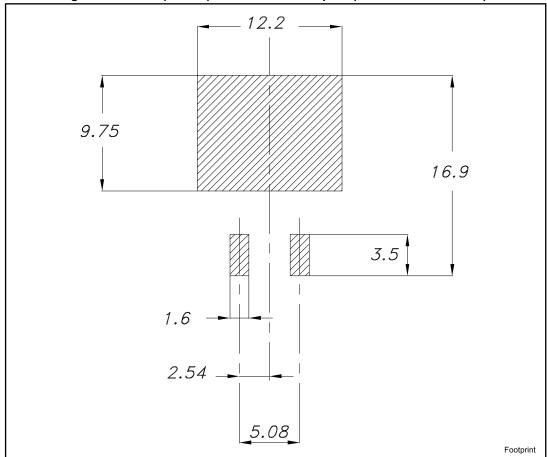
E1 c2-L1 THERMAL PAD SEATING PLANE COPLANARITY A 1 0.25 GAUGE PLANE V2_ 0079457_A_rev22

Figure 21: D²PAK (TO-263) type A package outline

Table 10: D²PAK (TO-263) type A package mechanical data

	mm				
Dim.	Min.	Тур.	Max.		
A	4.40		4.60		
A1	0.03		0.23		
b	0.70		0.93		
b2	1.14		1.70		
С	0.45		0.60		
c2	1.23		1.36		
D	8.95		9.35		
D1	7.50	7.75	8.00		
D2	1.10	1.30	1.50		
E	10		10.40		
E1	8.50	8.70	8.90		
E2	6.85	7.05	7.25		
е		2.54			
e1	4.88		5.28		
Н	15		15.85		
J1	2.49		2.69		
L	2.29		2.79		
L1	1.27		1.40		
L2	1.30		1.75		
R		0.4			
V2	0°		8°		

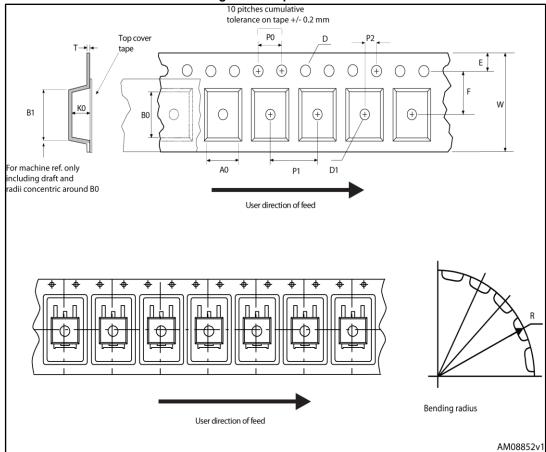
Figure 22: D²PAK (TO-263) recommended footprint (dimensions are in mm)



STB14N80K5 Package information

4.2 D²PAK (TO-263) packing information

Figure 23: Tape outline





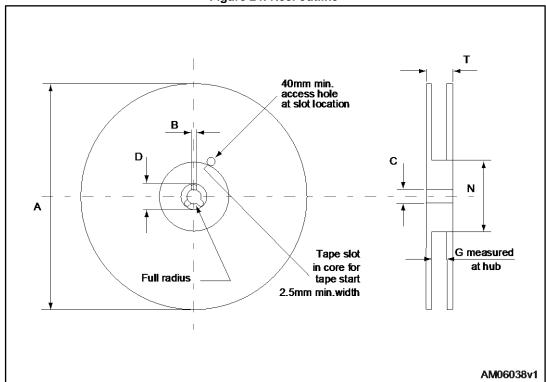


Table 11: D2PAK tape and reel mechanical data

Таре			Reel		
Dim.	mm		Dim	mm	
	Min.	Max.	Dim.	Min.	Max.
A0	10.5	10.7	А		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base quantity		1000
P2	1.9	2.1	Bulk quantity 1000		1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

STB14N80K5 Revision history

5 Revision history

Table 12: Document revision history

Date	Revision	Changes
18-Feb-2016	1	First release.

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